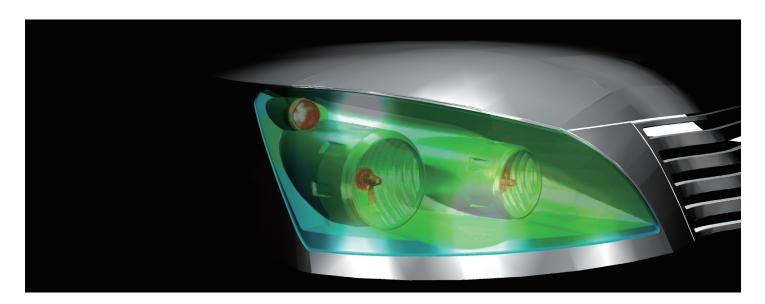


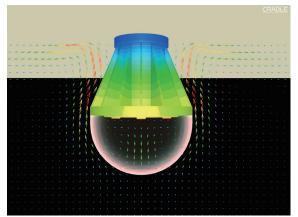
Heat Release Analysis of Lighting Equipment

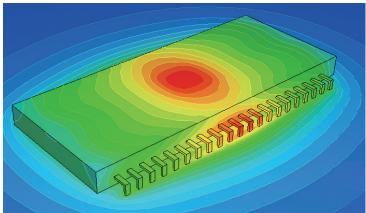
Case Studies of SC/Tetra, HeatDesigner, and scSTREAM





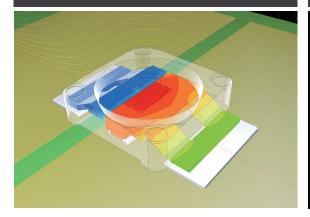
Semiconductor Devices

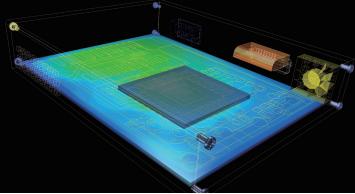




LED Devices

Heat Release Analysis Considering Gerber Data





Notes

It is a big challenge to effectively promote heat release from electronics components such as highly integrated LSI and LED, which is miniaturized further.

Thermal design is vital to develop high-quality products with more energy saving capability and longer duration. Simulation helps examine new ideas for thermal design specifically and clearly with visual insights.

© Software Cradle Co., Ltd. www.cradle-cfd.com